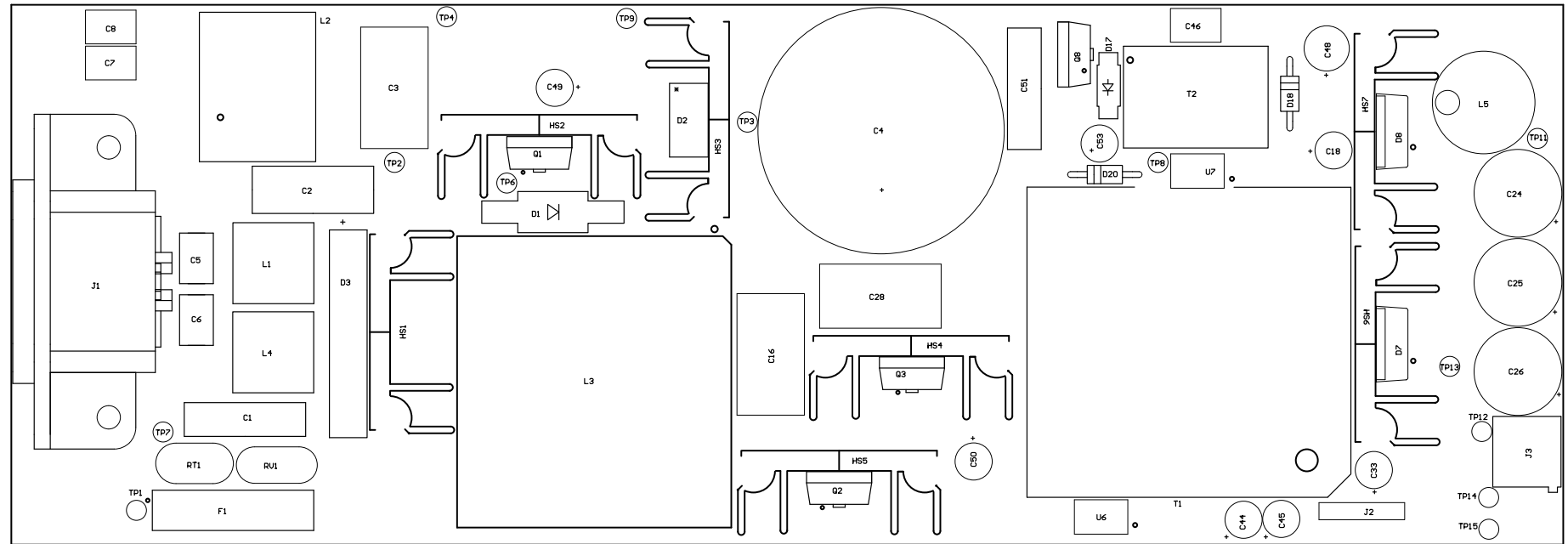


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00355	REV: REVC	SUN REV: Not In VersionControl
LAYER NAME = Top Paste			
PLOT NAME = TIDA-00355_REVC.GTP	GENERATED : 6/5/2015	2:49:31 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00355	REV: REUC	SUN REV: Not In VersionControl
LAYER NAME = Bottom Paste			
PLOT NAME = TIDA-00355_REUC.GBP	GENERATED : 6/5/2015 2:49:31 PM	TEXAS INSTRUMENTS	

- Z21 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

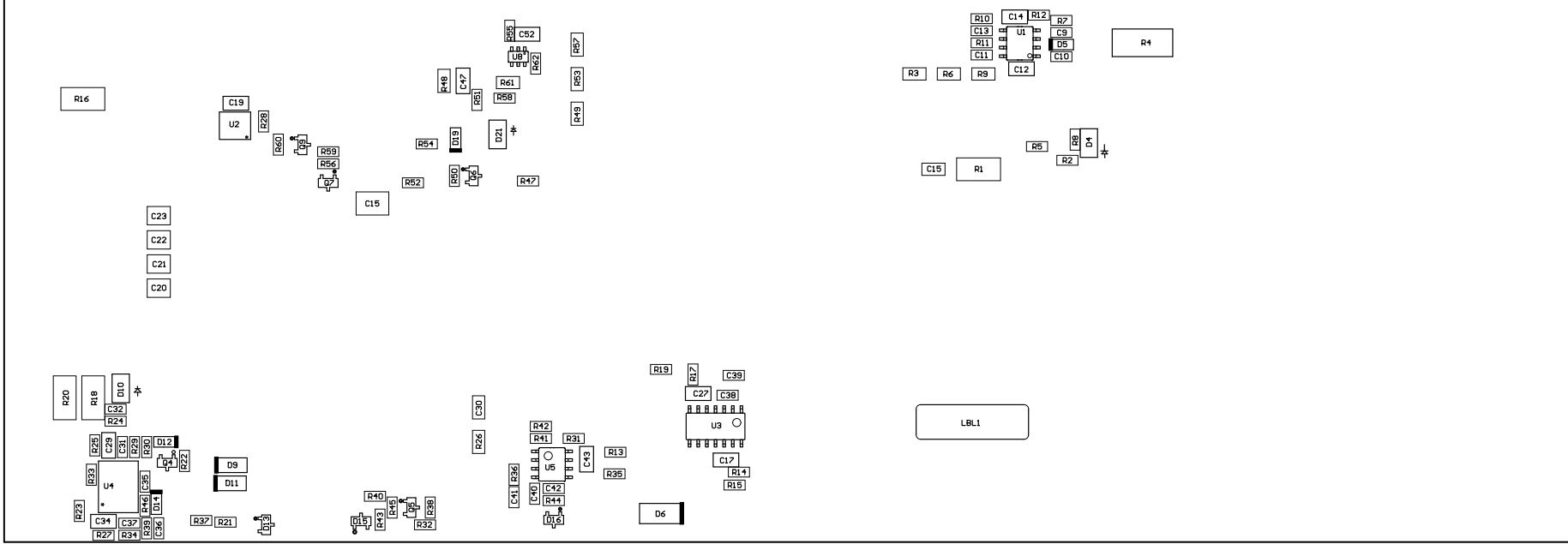


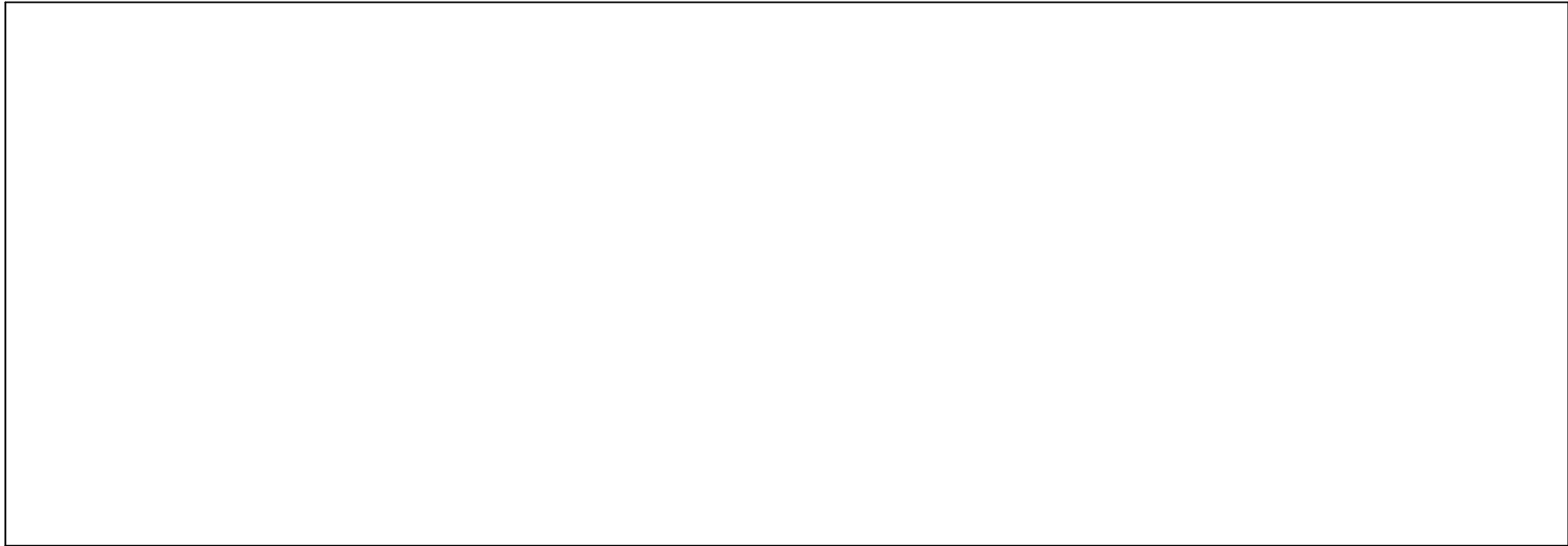
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #:	TIDA-00355	REV:	REUC	SUN REV:	Not In VersionControl
LAYER NAME =	M5 Assembly Top					
PLOT NAME =	TIDA-00355_REUC.6H5	GENERATED :	6/5/2015	2:50:37 PM	TEXAS INSTRUMENTS	

PLOT NAME = T10A-0038B_REV.C GRC LAYER NAME = ME Assembly Bottom BOARD # = T10A-0038B	REV: RENC GEN: RENC DATE: 9-2-2018 TIME: 2:20:32 PM	TEXTS INSTRUMENTS Not in worksheet Not in worksheet
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ASSEMBLY VARIANT [No variants]  
 COMPONENTS MARKED 'IMP.' SHOULD NOT BE POPULATED.





ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00355	REV: REVC	SUN REV: Not In VersionControl
LAYER NAME = M1 Board Outline			
PLOT NAME = TIDA-00355_REVC.GM1	GENERATED : 6/5/2015	2:49:31 PM	TEXAS INSTRUMENTS

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